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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |                                                                                                                                                                     |
|--------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Product Status                 | Active                                                                                                                                                              |
| Number of LABs/CLBs            | -                                                                                                                                                                   |
| Number of Logic Elements/Cells | 792                                                                                                                                                                 |
| Total RAM Bits                 | -                                                                                                                                                                   |
| Number of I/O                  | 120                                                                                                                                                                 |
| Number of Gates                | 30000                                                                                                                                                               |
| Voltage - Supply               | 1.425V ~ 1.575V                                                                                                                                                     |
| Mounting Type                  | Surface Mount                                                                                                                                                       |
| Operating Temperature          | -40°C ~ 100°C (TJ)                                                                                                                                                  |
| Package / Case                 | 201-VFBGA, CSBGA                                                                                                                                                    |
| Supplier Device Package        | 201-CSP (8x8)                                                                                                                                                       |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/microchip-technology/aglp030v5-cs201i">https://www.e-xfl.com/product-detail/microchip-technology/aglp030v5-cs201i</a> |

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## **Security**

Nonvolatile, flash-based IGLOO PLUS devices do not require a boot PROM, so there is no vulnerable external bitstream that can be easily copied. IGLOO PLUS devices incorporate FlashLock, which provides a unique combination of reprogrammability and design security without external overhead, advantages that only an FPGA with nonvolatile flash programming can offer.

IGLOO PLUS devices (except AGLP030) utilize a 128-bit flash-based lock and a separate AES key to provide the highest level of security in the FPGA industry for programmed intellectual property and configuration data. In addition, all FlashROM data in IGLOO PLUS devices can be encrypted prior to loading, using the industry-leading AES-128 (FIPS192) bit block cipher encryption standard. AES was adopted by the National Institute of Standards and Technology (NIST) in 2000 and replaces the 1977 DES standard. IGLOO PLUS devices have a built-in AES decryption engine and a flash-based AES key that make them the most comprehensive programmable logic device security solution available today. IGLOO PLUS devices with AES-based security provide a high level of protection for secure, remote field updates over public networks such as the Internet, and ensure that valuable IP remains out of the hands of system overbuilders, system cloners, and IP thieves.

Security, built into the FPGA fabric, is an inherent component of the IGLOO PLUS family. The flash cells are located beneath seven metal layers, and many device design and layout techniques have been used to make invasive attacks extremely difficult. The IGLOO PLUS family, with FlashLock and AES security, is unique in being highly resistant to both invasive and noninvasive attacks. Your valuable IP is protected with industry-standard security, making remote ISP possible. An IGLOO PLUS device provides the best available security for programmable logic designs.

## **Single Chip**

Flash-based FPGAs store their configuration information in on-chip flash cells. Once programmed, the configuration data is an inherent part of the FPGA structure, and no external configuration data needs to be loaded at system power-up (unlike SRAM-based FPGAs). Therefore, flash-based IGLOO PLUS FPGAs do not require system configuration components such as EEPROMs or microcontrollers to load device configuration data. This reduces bill-of-materials costs and PCB area, and increases security and system reliability.

The IGLOO PLUS devices can be operated with a 1.2 V or 1.5 V single-voltage supply for core and I/Os, eliminating the need for additional supplies while minimizing total power consumption.

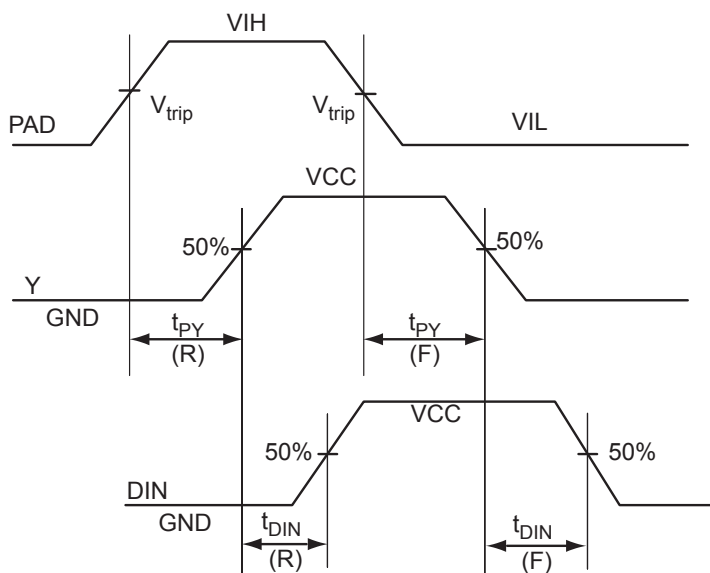
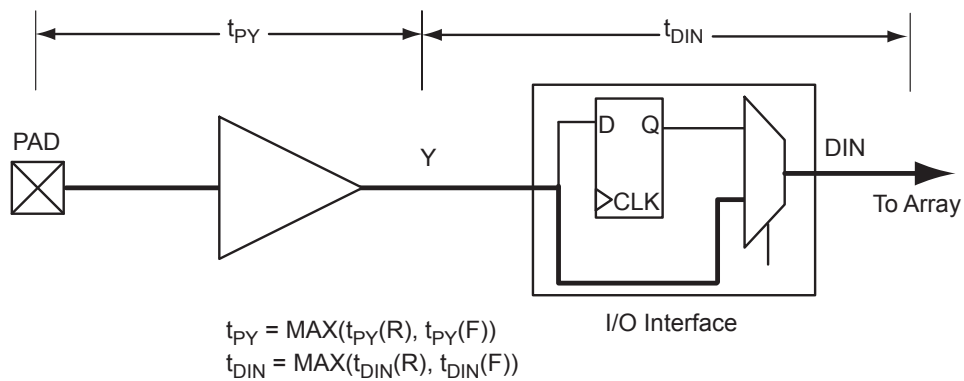
## **Instant On**

Flash-based IGLOO PLUS devices support Level 0 of the Instant On classification standard. This feature helps in system component initialization, execution of critical tasks before the processor wakes up, setup and configuration of memory blocks, clock generation, and bus activity management. The Instant On feature of flash-based IGLOO PLUS devices greatly simplifies total system design and reduces total system cost, often eliminating the need for CPLDs and clock generation PLLs. In addition, glitches and brownouts in system power will not corrupt the IGLOO PLUS device's flash configuration, and unlike SRAM-based FPGAs, the device will not have to be reloaded when system power is restored. This enables the reduction or complete removal of the configuration PROM, expensive voltage monitor, brownout detection, and clock generator devices from the PCB design. Flash-based IGLOO PLUS devices simplify total system design and reduce cost and design risk while increasing system reliability and improving system initialization time.

IGLOO PLUS flash FPGAs allow the user to quickly enter and exit Flash\*Freeze mode. This is done almost instantly (within 1  $\mu$ s), and the device retains configuration and data in registers and RAM. Unlike SRAM-based FPGAs, the device does not need to reload configuration and design state from external memory components; instead, it retains all necessary information to resume operation immediately.

## **Reduced Cost of Ownership**

Advantages to the designer extend beyond low unit cost, performance, and ease of use. Unlike SRAM-based FPGAs, flash-based IGLOO PLUS devices allow all functionality to be Instant On; no external boot PROM is required. On-board security mechanisms prevent access to all the programming information and enable secure remote updates of the FPGA logic. Designers can perform secure remote in-system reprogramming to support future design iterations and field upgrades with confidence that valuable intellectual property cannot be compromised or copied. Secure ISP can be performed using the industry-standard AES algorithm.


**Figure 2-4 • Input Buffer Timing Model and Delays (example)**

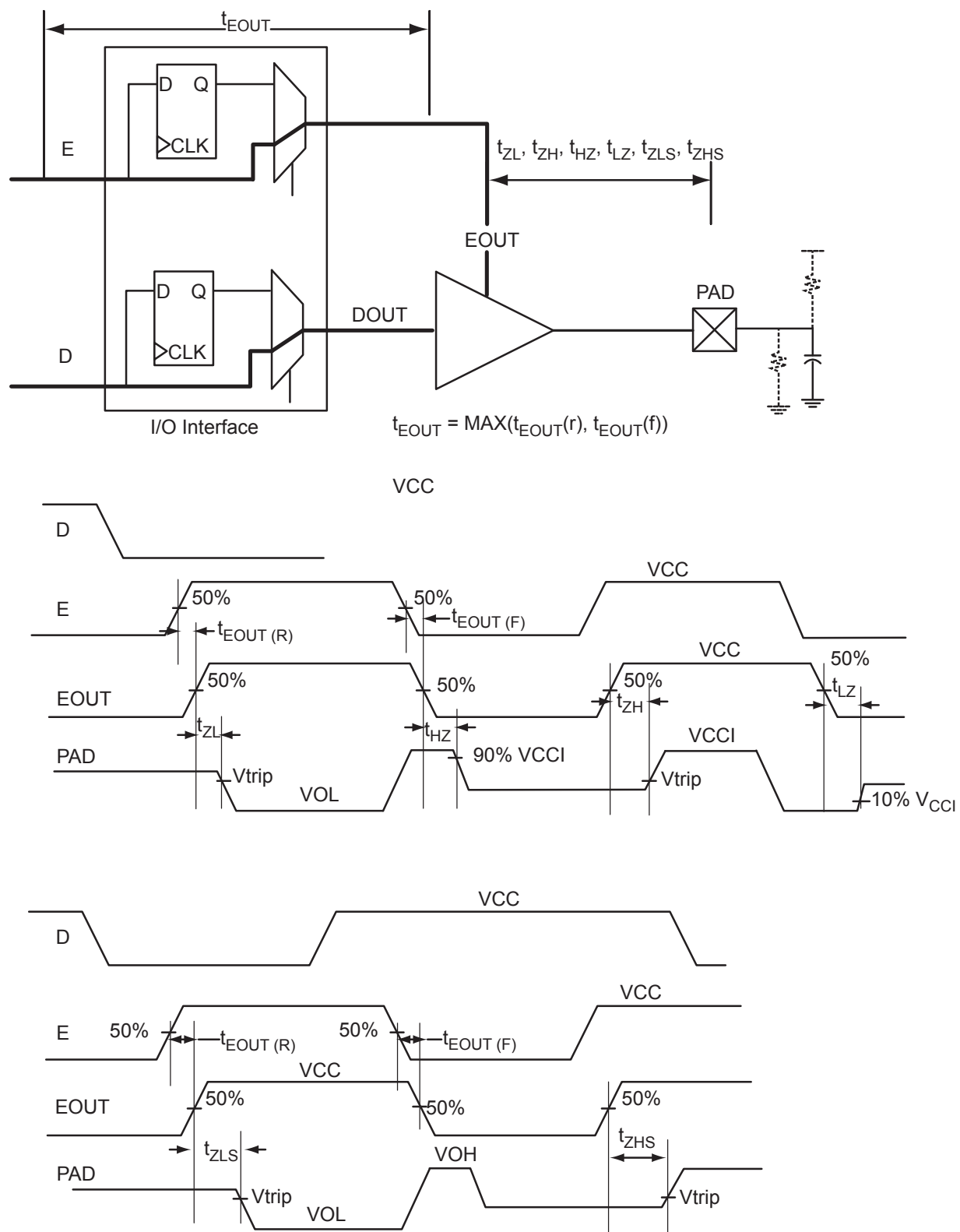


Figure 2-6 • Tristate Output Buffer Timing Model and Delays (example)

## Detailed I/O DC Characteristics

**Table 2-27 • Input Capacitance**

| Symbol      | Definition                         | Conditions                        | Min. | Max. | Units |
|-------------|------------------------------------|-----------------------------------|------|------|-------|
| $C_{IN}$    | Input capacitance                  | $V_{IN} = 0, f = 1.0 \text{ MHz}$ |      | 8    | pF    |
| $C_{INCLK}$ | Input capacitance on the clock pin | $V_{IN} = 0, f = 1.0 \text{ MHz}$ |      | 8    | pF    |

**Table 2-28 • I/O Output Buffer Maximum Resistances <sup>1</sup>**

| Standard                             | Drive Strength | $R_{PULL-DOWN}$<br>( $\Omega$ ) <sup>2</sup> | $R_{PULL-UP}$<br>( $\Omega$ ) <sup>3</sup> |
|--------------------------------------|----------------|----------------------------------------------|--------------------------------------------|
| 3.3 V LVTTTL / 3.3V LVCMOS           | 2 mA           | 100                                          | 300                                        |
|                                      | 4 mA           | 100                                          | 300                                        |
|                                      | 6 mA           | 50                                           | 150                                        |
|                                      | 8 mA           | 50                                           | 150                                        |
|                                      | 12 mA          | 25                                           | 75                                         |
|                                      | 16 mA          | 25                                           | 75                                         |
| 3.3 V LVCMOS Wide Range              | 100 $\mu$ A    | Same as equivalent software default drive    |                                            |
| 2.5 V LVCMOS                         | 2 mA           | 100                                          | 200                                        |
|                                      | 4 mA           | 100                                          | 200                                        |
|                                      | 6 mA           | 50                                           | 100                                        |
|                                      | 8 mA           | 50                                           | 100                                        |
|                                      | 12 mA          | 25                                           | 50                                         |
| 1.8 V LVCMOS                         | 2 mA           | 200                                          | 225                                        |
|                                      | 4 mA           | 100                                          | 112                                        |
|                                      | 6 mA           | 50                                           | 56                                         |
|                                      | 8 mA           | 50                                           | 56                                         |
| 1.5 V LVCMOS                         | 2 mA           | 200                                          | 224                                        |
|                                      | 4 mA           | 100                                          | 112                                        |
| 1.2 V LVCMOS                         | 2 mA           | 157.5                                        | 163.8                                      |
| 1.2 V LVCMOS Wide Range <sup>4</sup> | 100 $\mu$ A    | 157.5                                        | 163.8                                      |

**Notes:**

1. These maximum values are provided for informational reasons only. Minimum output buffer resistance values depend on  $V_{CC_I}$ , drive strength selection, temperature, and process. For board design considerations and detailed output buffer resistances, use the corresponding IBIS model on the Microsemi SoC Products Group website at <http://www.microsemi.com/soc/download/ibis/default.aspx>.
2.  $R_{(PULL-DOWN-MAX)} = (V_{OLspec}) / I_{OLspec}$
3.  $R_{(PULL-UP-MAX)} = (V_{CCI}max - V_{OHspec}) / I_{OHspec}$
4. Applicable to IGLOO PLUS V2 devices operating at  $V_{CCI} \geq V_{CC}$ .

## Single-Ended I/O Characteristics

### 3.3 V LVTTTL / 3.3 V LVCMOS

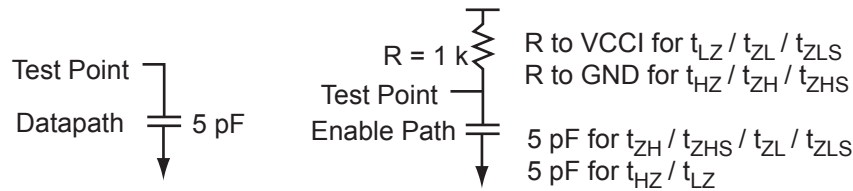
Low-Voltage Transistor–Transistor Logic (LVTTTL) is a general-purpose standard (EIA/JESD) for 3.3 V applications. It uses an LVTTTL input buffer and push-pull output buffer.

**Table 2-34 • Minimum and Maximum DC Input and Output Levels**

| 3.3 V LVTTTL /<br>3.3 V LVCMOS | VIL       |           | VIH       |           | VOL       | VOH       | IOL | IOH | IOSL                    | IOSH                    | IIL <sup>1</sup> | IIH <sup>2</sup> |
|--------------------------------|-----------|-----------|-----------|-----------|-----------|-----------|-----|-----|-------------------------|-------------------------|------------------|------------------|
| Drive<br>Strength              | Min.<br>V | Max.<br>V | Min.<br>V | Max.<br>V | Max.<br>V | Min.<br>V | mA  | mA  | Max.<br>mA <sup>3</sup> | Max.<br>mA <sup>3</sup> | μA <sup>4</sup>  | μA <sup>4</sup>  |
| 2 mA                           | −0.3      | 0.8       | 2         | 3.6       | 0.4       | 2.4       | 2   | 2   | 25                      | 27                      | 10               | 10               |
| 4 mA                           | −0.3      | 0.8       | 2         | 3.6       | 0.4       | 2.4       | 4   | 4   | 25                      | 27                      | 10               | 10               |
| 6 mA                           | −0.3      | 0.8       | 2         | 3.6       | 0.4       | 2.4       | 6   | 6   | 51                      | 54                      | 10               | 10               |
| 8 mA                           | −0.3      | 0.8       | 2         | 3.6       | 0.4       | 2.4       | 8   | 8   | 51                      | 54                      | 10               | 10               |
| 12 mA                          | −0.3      | 0.8       | 2         | 3.6       | 0.4       | 2.4       | 12  | 12  | 103                     | 109                     | 10               | 10               |
| 16 mA                          | −0.3      | 0.8       | 2         | 3.6       | 0.4       | 2.4       | 16  | 16  | 103                     | 109                     | 10               | 10               |

**Notes:**

1. IIL is the input leakage current per I/O pin over recommended operation conditions where  $-0.3\text{ V} < V_{IN} < V_{IL}$ .
2. IIH is the input leakage current per I/O pin over recommended operating conditions  $V_{IH} < V_{IN} < V_{CCI}$ . Input current is larger when operating outside recommended ranges.
3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
4. Currents are measured at 85°C junction temperature.
5. Software default selection highlighted in gray.



**Figure 2-7 • AC Loading**

**Table 2-35 • AC Waveforms, Measuring Points, and Capacitive Loads**

| Input Low (V) | Input High (V) | Measuring Point* (V) | C <sub>LOAD</sub> (pF) |
|---------------|----------------|----------------------|------------------------|
| 0             | 3.3            | 1.4                  | 5                      |

**Note:** \*Measuring point = Vtrip. See [Table 2-23 on page 2-20](#) for a complete table of trip points.

**Table 2-39 • 3.3 V LVTTTL / 3.3 V LVCMOS High Slew – Applies to 1.2 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case  $V_{CC} = 1.14\text{ V}$ , Worst-Case  $V_{CCI} = 3.0\text{ V}$ 

| Drive Strength | Speed Grade | $t_{DOUT}$ | $t_{DP}$ | $t_{DIN}$ | $t_{PY}$ | $t_{PYS}$ | $t_{EOUT}$ | $t_{ZL}$ | $t_{ZH}$ | $t_{LZ}$ | $t_{HZ}$ | Units |
|----------------|-------------|------------|----------|-----------|----------|-----------|------------|----------|----------|----------|----------|-------|
| 2 mA           | STD         | 0.98       | 2.92     | 0.19      | 0.99     | 1.37      | 0.67       | 2.97     | 2.38     | 2.25     | 2.70     | ns    |
| 4 mA           | STD         | 0.98       | 2.92     | 0.19      | 0.99     | 1.37      | 0.67       | 2.97     | 2.38     | 2.25     | 2.70     | ns    |
| 6 mA           | STD         | 0.98       | 2.52     | 0.19      | 0.99     | 1.37      | 0.67       | 2.56     | 2.03     | 2.49     | 3.11     | ns    |
| 8 mA           | STD         | 0.98       | 2.52     | 0.19      | 0.99     | 1.37      | 0.67       | 2.56     | 2.03     | 2.49     | 3.11     | ns    |
| 12 mA          | STD         | 0.98       | 2.31     | 0.19      | 0.99     | 1.37      | 0.67       | 2.34     | 1.86     | 2.65     | 3.38     | ns    |
| 16 mA          | STD         | 0.98       | 2.31     | 0.19      | 0.99     | 1.37      | 0.67       | 2.34     | 1.86     | 2.65     | 3.38     | ns    |

**Notes:**

- For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.
- Software default selection highlighted in gray

### 3.3 V LVCMOS Wide Range

**Table 2-40 • Minimum and Maximum DC Input and Output Levels**

| 3.3 V LVCMOS Wide Range | Equivalent Software Default Drive Strength Option <sup>1</sup> | VIL    |        | VIH    |        | VOL    | VOH            | IOL           | IOH           | IOSL                 | IOSH                 | IIL <sup>2</sup> | IIH <sup>3</sup> |
|-------------------------|----------------------------------------------------------------|--------|--------|--------|--------|--------|----------------|---------------|---------------|----------------------|----------------------|------------------|------------------|
|                         |                                                                | Min. V | Max. V | Min. V | Max. V | Max. V | Min. V         | $\mu\text{A}$ | $\mu\text{A}$ | Max. $\mu\text{A}^4$ | Max. $\mu\text{A}^4$ | $\mu\text{A}^5$  | $\mu\text{A}^5$  |
| 100 $\mu\text{A}$       | 2 mA                                                           | -0.3   | 0.8    | 2      | 3.6    | 0.2    | $V_{DD} - 0.2$ | 100           | 100           | 25                   | 27                   | 10               | 10               |
| 100 $\mu\text{A}$       | 4 mA                                                           | -0.3   | 0.8    | 2      | 3.6    | 0.4    | $V_{DD} - 0.2$ | 100           | 100           | 25                   | 27                   | 10               | 10               |
| 100 $\mu\text{A}$       | 6 mA                                                           | -0.3   | 0.8    | 2      | 3.6    | 0.4    | $V_{DD} - 0.2$ | 100           | 100           | 51                   | 54                   | 10               | 10               |
| 100 $\mu\text{A}$       | 8 mA                                                           | -0.3   | 0.8    | 2      | 3.6    | 0.4    | $V_{DD} - 0.2$ | 100           | 100           | 51                   | 54                   | 10               | 10               |
| 100 $\mu\text{A}$       | 12 mA                                                          | -0.3   | 0.8    | 2      | 3.6    | 0.4    | $V_{DD} - 0.2$ | 100           | 100           | 103                  | 109                  | 10               | 10               |
| 100 $\mu\text{A}$       | 16 mA                                                          | -0.3   | 0.8    | 2      | 3.6    | 0.4    | $V_{DD} - 0.2$ | 100           | 100           | 103                  | 109                  | 10               | 10               |

**Notes:**

- The minimum drive strength for any LVCMOS 3.3 V software configuration when run in wide range is  $\pm 100\text{ }\mu\text{A}$ . Drive strength displayed in the software is supported for normal range only. For a detailed I/V curve, refer to the IBIS models.
- IIL is the input leakage current per I/O pin over recommended operation conditions where  $-0.3\text{ V} < V_{IN} < V_{IL}$ .
- IIH is the input leakage current per I/O pin over recommended operating conditions  $V_{IH} < V_{IN} < V_{CCI}$ . Input current is larger when operating outside recommended ranges.
- Currents are measured at high temperature ( $100^\circ\text{C}$  junction temperature) and maximum voltage.
- Currents are measured at  $85^\circ\text{C}$  junction temperature.
- Software default selection highlighted in gray.

**Table 2-41 • AC Waveforms, Measuring Points, and Capacitive Loads**

| Input Low (V) | Input High (V) | Measuring Point* (V) | $C_{LOAD}$ (pF) |
|---------------|----------------|----------------------|-----------------|
| 0             | 3.3            | 1.4                  | 5               |

**Note:** \*Measuring point =  $V_{trip}$ . See [Table 2-23 on page 2-20](#) for a complete table of trip points.

## Timing Characteristics

### Applies to 1.5 V DC Core Voltage

**Table 2-48 • 2.5 V LVCMOS Low Slew – Applies to 1.5 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V

| Drive Strength | Speed Grade | $t_{DOUT}$ | $t_{DP}$ | $t_{DIN}$ | $t_{PY}$ | $t_{PYS}$ | $t_{EOUT}$ | $t_{ZL}$ | $t_{ZH}$ | $t_{LZ}$ | $t_{HZ}$ | Units |
|----------------|-------------|------------|----------|-----------|----------|-----------|------------|----------|----------|----------|----------|-------|
| 4 mA           | STD         | 0.97       | 4.44     | 0.18      | 1.06     | 1.22      | 0.66       | 4.53     | 4.15     | 1.80     | 1.70     | ns    |
| 6 mA           | STD         | 0.97       | 3.61     | 0.18      | 1.06     | 1.22      | 0.66       | 3.69     | 3.50     | 2.05     | 2.18     | ns    |
| 8 mA           | STD         | 0.97       | 3.61     | 0.18      | 1.06     | 1.22      | 0.66       | 3.69     | 3.50     | 2.05     | 2.18     | ns    |
| 12 mA          | STD         | 0.97       | 3.07     | 0.18      | 1.06     | 1.22      | 0.66       | 3.14     | 3.03     | 2.22     | 2.48     | ns    |

*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

**Table 2-49 • 2.5 V LVCMOS High Slew – Applies to 1.5 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case VCC = 1.425 V, Worst-Case VCCI = 2.3 V

| Drive Strength | Speed Grade | $t_{DOUT}$ | $t_{DP}$ | $t_{DIN}$ | $t_{PY}$ | $t_{PYS}$ | $t_{EOUT}$ | $t_{ZL}$ | $t_{ZH}$ | $t_{LZ}$ | $t_{HZ}$ | Units |
|----------------|-------------|------------|----------|-----------|----------|-----------|------------|----------|----------|----------|----------|-------|
| 4 mA           | STD         | 0.97       | 2.41     | 0.18      | 1.06     | 1.22      | 0.66       | 2.47     | 2.22     | 1.79     | 1.77     | ns    |
| 6 mA           | STD         | 0.97       | 1.99     | 0.18      | 1.06     | 1.22      | 0.66       | 2.04     | 1.75     | 2.04     | 2.25     | ns    |
| 8 mA           | STD         | 0.97       | 1.99     | 0.18      | 1.06     | 1.22      | 0.66       | 2.04     | 1.75     | 2.04     | 2.25     | ns    |
| 12 mA          | STD         | 0.97       | 1.77     | 0.18      | 1.06     | 1.22      | 0.66       | 1.81     | 1.51     | 2.22     | 2.56     | ns    |

**Notes:**

- For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.
- Software default selection highlighted in gray.

### Applies to 1.2 V DC Core Voltage

**Table 2-50 • 2.5 V LVCMOS Low Slew – Applies to 1.2 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case VCC = 1.14 V, Worst-Case VCCI = 2.3 V

| Drive Strength | Speed Grade | $t_{DOUT}$ | $t_{DP}$ | $t_{DIN}$ | $t_{PY}$ | $t_{PYS}$ | $t_{EOUT}$ | $t_{ZL}$ | $t_{ZH}$ | $t_{LZ}$ | $t_{HZ}$ | Units |
|----------------|-------------|------------|----------|-----------|----------|-----------|------------|----------|----------|----------|----------|-------|
| 4 mA           | STD         | 0.98       | 5.04     | 0.19      | 1.19     | 1.40      | 0.67       | 5.12     | 4.65     | 2.22     | 2.36     | ns    |
| 6 mA           | STD         | 0.98       | 4.19     | 0.19      | 1.19     | 1.40      | 0.67       | 4.25     | 3.98     | 2.48     | 2.85     | ns    |
| 8 mA           | STD         | 0.98       | 4.19     | 0.19      | 1.19     | 1.40      | 0.67       | 4.25     | 3.98     | 2.48     | 2.85     | ns    |
| 12 mA          | STD         | 0.98       | 3.63     | 0.19      | 1.19     | 1.40      | 0.67       | 3.69     | 3.50     | 2.66     | 3.16     | ns    |

*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

**Table 2-51 • 2.5 V LVCMOS High Slew – Applies to 1.2 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case VCC = 1.14 V, Worst-Case VCCI = 2.3 V

| Drive Strength | Speed Grade | $t_{DOUT}$ | $t_{DP}$ | $t_{DIN}$ | $t_{PY}$ | $t_{PYS}$ | $t_{EOUT}$ | $t_{ZL}$ | $t_{ZH}$ | $t_{LZ}$ | $t_{HZ}$ | Units |
|----------------|-------------|------------|----------|-----------|----------|-----------|------------|----------|----------|----------|----------|-------|
| 4 mA           | STD         | 0.98       | 2.96     | 0.19      | 1.19     | 1.40      | 0.67       | 3.00     | 2.67     | 2.22     | 2.46     | ns    |
| 6 mA           | STD         | 0.98       | 2.52     | 0.19      | 1.19     | 1.40      | 0.67       | 2.56     | 2.18     | 2.47     | 2.95     | ns    |
| 8 mA           | STD         | 0.98       | 2.52     | 0.19      | 1.19     | 1.40      | 0.67       | 2.56     | 2.18     | 2.47     | 2.95     | ns    |
| 12 mA          | STD         | 0.98       | 2.29     | 0.19      | 1.19     | 1.40      | 0.67       | 2.32     | 1.94     | 2.65     | 3.27     | ns    |

**Notes:**

- For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.
- Software default selection highlighted in gray.

## 1.8 V LVCMOS

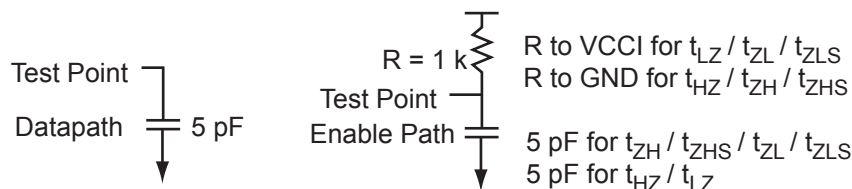
Low-voltage CMOS for 1.8 V is an extension of the LVCMOS standard (JESD8-5) used for general-purpose 1.8 V applications. It uses a 1.8 V input buffer and a push-pull output buffer.

**Table 2-52 • Minimum and Maximum DC Input and Output Levels**

| 1.8 V<br>LVCMOS   | VIL     |             | VIH         |         | VOL     | VOH         | IOL | IOH | IOSL                  | IOSH                  | IIL <sup>1</sup> | IIH <sup>2</sup> |
|-------------------|---------|-------------|-------------|---------|---------|-------------|-----|-----|-----------------------|-----------------------|------------------|------------------|
| Drive<br>Strength | Min., V | Max., V     | Min., V     | Max., V | Max., V | Min., V     | mA  | mA  | Max., mA <sup>3</sup> | Max., mA <sup>3</sup> | μA <sup>4</sup>  | μA <sup>4</sup>  |
| 2 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 2   | 2   | 9                     | 11                    | 10               | 10               |
| 4 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 4   | 4   | 17                    | 22                    | 10               | 10               |
| 6 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 6   | 6   | 35                    | 44                    | 10               | 10               |
| 8 mA              | −0.3    | 0.35 * VCCI | 0.65 * VCCI | 3.6     | 0.45    | VCCI − 0.45 | 8   | 8   | 35                    | 44                    | 10               | 10               |

**Notes:**

1. IIL is the input leakage current per I/O pin over recommended operation conditions where  $-0.3\text{ V} < V_{IN} < V_{IL}$ .
2. IIH is the input leakage current per I/O pin over recommended operating conditions  $V_{IH} < V_{IN} < V_{CCI}$ . Input current is larger when operating outside recommended ranges.
3. Currents are measured at high temperature (100°C junction temperature) and maximum voltage.
4. Currents are measured at 85°C junction temperature.
5. Software default selection highlighted in gray.



**Figure 2-9 • AC Loading**

**Table 2-53 • AC Waveforms, Measuring Points, and Capacitive Loads**

| Input Low (V) | Input High (V) | Measuring Point* (V) | C <sub>LOAD</sub> (pF) |
|---------------|----------------|----------------------|------------------------|
| 0             | 1.8            | 0.9                  | 5                      |

**Note:** \*Measuring point = Vtrip. See Table 2-23 on page 2-20 for a complete table of trip points.

## Timing Characteristics

### Applies to 1.5 V DC Core Voltage

**Table 2-60 • 1.5 V LVCMOS Low Slew – Applies to 1.5 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ , Worst-Case VCC = 1.425 V, Worst-Case VCCI = 1.4 V

| Drive Strength | Speed Grade | $t_{\text{DOUT}}$ | $t_{\text{DP}}$ | $t_{\text{DIN}}$ | $t_{\text{PY}}$ | $t_{\text{PYS}}$ | $t_{\text{EOUT}}$ | $t_{\text{ZL}}$ | $t_{\text{ZH}}$ | $t_{\text{LZ}}$ | $t_{\text{HZ}}$ | Units |
|----------------|-------------|-------------------|-----------------|------------------|-----------------|------------------|-------------------|-----------------|-----------------|-----------------|-----------------|-------|
| 2 mA           | STD         | 0.97              | 6.07            | 0.18             | 1.16            | 1.62             | 0.66              | 6.19            | 5.53            | 2.13            | 2.02            | ns    |
| 4 mA           | STD         | 0.97              | 5.24            | 0.18             | 1.16            | 1.62             | 0.66              | 5.34            | 4.81            | 2.37            | 2.47            | ns    |

*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

**Table 2-61 • 1.5 V LVCMOS High Slew – Applies to 1.5 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ , Worst-Case VCC = 1.425 V, Worst-Case VCCI = 1.4 V

| Drive Strength | Speed Grade | $t_{\text{DOUT}}$ | $t_{\text{DP}}$ | $t_{\text{DIN}}$ | $t_{\text{PY}}$ | $t_{\text{PYS}}$ | $t_{\text{EOUT}}$ | $t_{\text{ZL}}$ | $t_{\text{ZH}}$ | $t_{\text{LZ}}$ | $t_{\text{HZ}}$ | Units |
|----------------|-------------|-------------------|-----------------|------------------|-----------------|------------------|-------------------|-----------------|-----------------|-----------------|-----------------|-------|
| 2 mA           | STD         | 0.97              | 2.65            | 0.18             | 1.16            | 1.62             | 0.66              | 2.71            | 2.43            | 2.13            | 2.11            | ns    |
| 4 mA           | STD         | 0.97              | 2.29            | 0.18             | 1.16            | 1.62             | 0.66              | 2.33            | 2.00            | 2.37            | 2.57            | ns    |

#### Notes:

- For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.
- Software default selection highlighted in gray.

### Applies to 1.2 V DC Core Voltage

**Table 2-62 • 1.5 V LVCMOS Low Slew – Applies to 1.2 V DC Core Voltage**

Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ , Worst-Case VCC = 1.14 V, Worst-Case VCCI = 1.4 V

| Drive Strength | Speed Grade | $t_{\text{DOUT}}$ | $t_{\text{DP}}$ | $t_{\text{DIN}}$ | $t_{\text{PY}}$ | $t_{\text{PYS}}$ | $t_{\text{EOUT}}$ | $t_{\text{ZL}}$ | $t_{\text{ZH}}$ | $t_{\text{LZ}}$ | $t_{\text{HZ}}$ | Units |
|----------------|-------------|-------------------|-----------------|------------------|-----------------|------------------|-------------------|-----------------|-----------------|-----------------|-----------------|-------|
| 2 mA           | STD         | 0.98              | 6.57            | 0.19             | 1.26            | 1.80             | 0.67              | 6.68            | 6.01            | 2.54            | 2.59            | ns    |
| 4 mA           | STD         | 0.98              | 5.72            | 0.19             | 1.26            | 1.80             | 0.67              | 5.81            | 5.27            | 2.79            | 3.05            | ns    |

*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

**Table 2-63 • 1.5 V LVCMOS High Slew – Applies to 1.2 V DC Core Voltage**

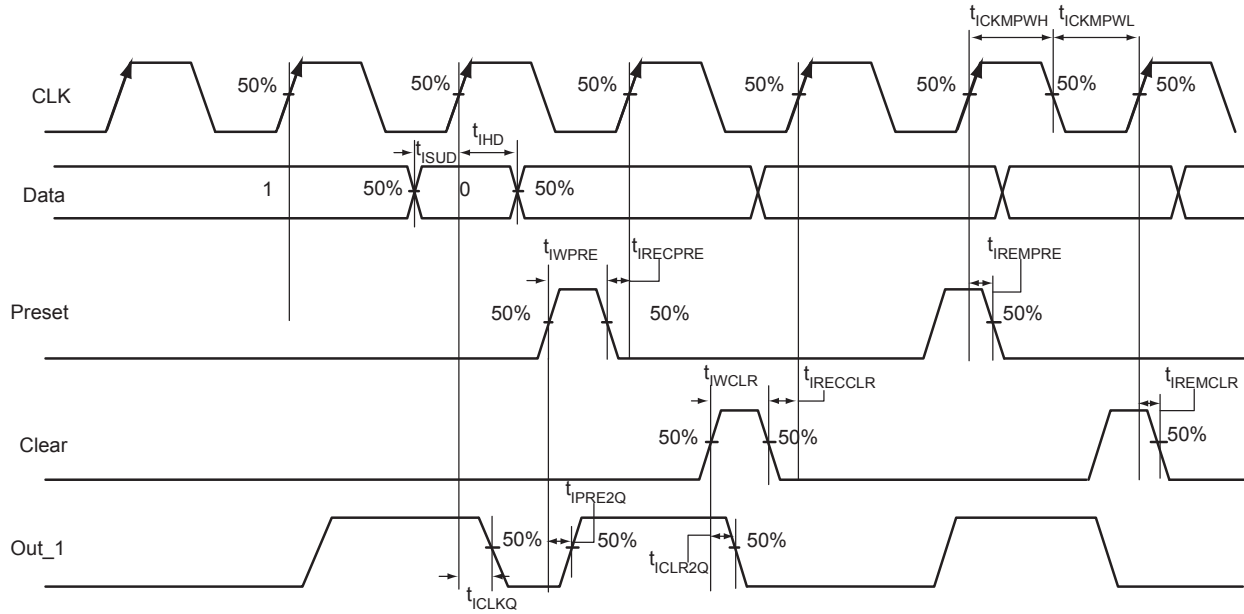
Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ , Worst-Case VCC = 1.14 V, Worst-Case VCCI = 1.4 V

| Drive Strength | Speed Grade | $t_{\text{DOUT}}$ | $t_{\text{DP}}$ | $t_{\text{DIN}}$ | $t_{\text{PY}}$ | $t_{\text{PYS}}$ | $t_{\text{EOUT}}$ | $t_{\text{ZL}}$ | $t_{\text{ZH}}$ | $t_{\text{LZ}}$ | $t_{\text{HZ}}$ | Units |
|----------------|-------------|-------------------|-----------------|------------------|-----------------|------------------|-------------------|-----------------|-----------------|-----------------|-----------------|-------|
| 2 mA           | STD         | 0.98              | 3.08            | 0.19             | 1.26            | 1.80             | 0.67              | 3.13            | 2.82            | 2.53            | 2.68            | ns    |
| 4 mA           | STD         | 0.98              | 2.71            | 0.19             | 1.26            | 1.80             | 0.67              | 2.75            | 2.39            | 2.78            | 3.15            | ns    |

#### Notes:

- For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.
- Software default selection highlighted in gray.

## Input Register



**Figure 2-14 • Input Register Timing Diagram**

### Timing Characteristics

1.5 V DC Core Voltage

**Table 2-74 • Input Data Register Propagation Delays**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case  $V_{CC} = 1.425\text{ V}$

| Parameter           | Description                                                         | Std. | Units |
|---------------------|---------------------------------------------------------------------|------|-------|
| $t_{\text{ICLKQ}}$  | Clock-to-Q of the Input Data Register                               | 0.41 | ns    |
| $t_{\text{ISUD}}$   | Data Setup Time for the Input Data Register                         | 0.32 | ns    |
| $t_{\text{IHD}}$    | Data Hold Time for the Input Data Register                          | 0.00 | ns    |
| $t_{\text{ICLR2Q}}$ | Asynchronous Clear-to-Q of the Input Data Register                  | 0.57 | ns    |
| $t_{\text{IPRE2Q}}$ | Asynchronous Preset-to-Q of the Input Data Register                 | 0.57 | ns    |
| $t_{\text{IEMCLR}}$ | Asynchronous Clear Removal Time for the Input Data Register         | 0.00 | ns    |
| $t_{\text{RECCLR}}$ | Asynchronous Clear Recovery Time for the Input Data Register        | 0.24 | ns    |
| $t_{\text{IEMPRE}}$ | Asynchronous Preset Removal Time for the Input Data Register        | 0.00 | ns    |
| $t_{\text{RECPRE}}$ | Asynchronous Preset Recovery Time for the Input Data Register       | 0.24 | ns    |
| $t_{\text{WCLR}}$   | Asynchronous Clear Minimum Pulse Width for the Input Data Register  | 0.19 | ns    |
| $t_{\text{WPRE}}$   | Asynchronous Preset Minimum Pulse Width for the Input Data Register | 0.19 | ns    |
| $t_{\text{CKMPWH}}$ | Clock Minimum Pulse Width High for the Input Data Register          | 0.31 | ns    |
| $t_{\text{CKMPWL}}$ | Clock Minimum Pulse Width Low for the Input Data Register           | 0.28 | ns    |

*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

### 1.2 V DC Core Voltage

**Table 2-75 • Input Data Register Propagation Delays**

Commercial-Case Conditions:  $T_J = 70^{\circ}\text{C}$ , Worst-Case  $V_{CC} = 1.14\text{ V}$ 

| Parameter           | Description                                                         | Std. | Units |
|---------------------|---------------------------------------------------------------------|------|-------|
| $t_{\text{CLKQ}}$   | Clock-to-Q of the Input Data Register                               | 0.66 | ns    |
| $t_{\text{SUD}}$    | Data Setup Time for the Input Data Register                         | 0.43 | ns    |
| $t_{\text{IHD}}$    | Data Hold Time for the Input Data Register                          | 0.00 | ns    |
| $t_{\text{CLR2Q}}$  | Asynchronous Clear-to-Q of the Input Data Register                  | 0.86 | ns    |
| $t_{\text{PRE2Q}}$  | Asynchronous Preset-to-Q of the Input Data Register                 | 0.86 | ns    |
| $t_{\text{REMCLR}}$ | Asynchronous Clear Removal Time for the Input Data Register         | 0.00 | ns    |
| $t_{\text{RECCLR}}$ | Asynchronous Clear Recovery Time for the Input Data Register        | 0.24 | ns    |
| $t_{\text{REMPRE}}$ | Asynchronous Preset Removal Time for the Input Data Register        | 0.00 | ns    |
| $t_{\text{RECPRE}}$ | Asynchronous Preset Recovery Time for the Input Data Register       | 0.24 | ns    |
| $t_{\text{WCLR}}$   | Asynchronous Clear Minimum Pulse Width for the Input Data Register  | 0.19 | ns    |
| $t_{\text{WPRE}}$   | Asynchronous Preset Minimum Pulse Width for the Input Data Register | 0.19 | ns    |
| $t_{\text{CKMPWH}}$ | Clock Minimum Pulse Width High for the Input Data Register          | 0.31 | ns    |
| $t_{\text{CKMPWL}}$ | Clock Minimum Pulse Width Low for the Input Data Register           | 0.28 | ns    |

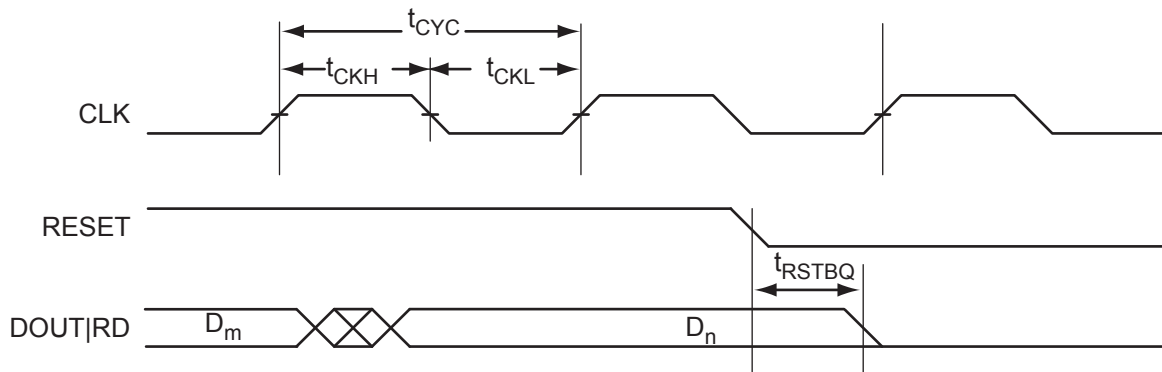
*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-7 on page 2-6](#) for derating values.

### 1.2 V DC Core Voltage

**Table 2-79 • Output Enable Register Propagation Delays**  
Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case  $V_{CC} = 1.14\text{ V}$

| Parameter      | Description                                                            | Std. | Units |
|----------------|------------------------------------------------------------------------|------|-------|
| $t_{OECLKQ}$   | Clock-to-Q of the Output Enable Register                               | 1.06 | ns    |
| $t_{OESUD}$    | Data Setup Time for the Output Enable Register                         | 0.52 | ns    |
| $t_{OEHD}$     | Data Hold Time for the Output Enable Register                          | 0.00 | ns    |
| $t_{OECLR2Q}$  | Asynchronous Clear-to-Q of the Output Enable Register                  | 1.25 | ns    |
| $t_{OEPRE2Q}$  | Asynchronous Preset-to-Q of the Output Enable Register                 | 1.36 | ns    |
| $t_{OEREMCLR}$ | Asynchronous Clear Removal Time for the Output Enable Register         | 0.00 | ns    |
| $t_{OERECCLR}$ | Asynchronous Clear Recovery Time for the Output Enable Register        | 0.24 | ns    |
| $t_{OEREMPRE}$ | Asynchronous Preset Removal Time for the Output Enable Register        | 0.00 | ns    |
| $t_{OERECPRE}$ | Asynchronous Preset Recovery Time for the Output Enable Register       | 0.24 | ns    |
| $t_{OEWCCLR}$  | Asynchronous Clear Minimum Pulse Width for the Output Enable Register  | 0.19 | ns    |
| $t_{OEWPPE}$   | Asynchronous Preset Minimum Pulse Width for the Output Enable Register | 0.19 | ns    |
| $t_{OECKMPWH}$ | Clock Minimum Pulse Width High for the Output Enable Register          | 0.31 | ns    |
| $t_{OECKMPWL}$ | Clock Minimum Pulse Width Low for the Output Enable Register           | 0.28 | ns    |

*Note:* For specific junction temperature and voltage supply levels, refer to [Table 2-7 on page 2-6](#) for derating values.



**Figure 2-28 • RAM Reset**

**Table 2-93 • RAM512X18**

Commercial-Case Conditions:  $T_J = 70^\circ\text{C}$ , Worst-Case  $V_{CC} = 1.425\text{ V}$

| Parameter      | Description                                                                                                          | Std. | Units |
|----------------|----------------------------------------------------------------------------------------------------------------------|------|-------|
| $t_{AS}$       | Address setup time                                                                                                   | 0.69 | ns    |
| $t_{AH}$       | Address hold time                                                                                                    | 0.13 | ns    |
| $t_{ENS}$      | REN, WEN setup time                                                                                                  | 0.61 | ns    |
| $t_{ENH}$      | REN, WEN hold time                                                                                                   | 0.07 | ns    |
| $t_{DS}$       | Input data (WD) setup time                                                                                           | 0.59 | ns    |
| $t_{DH}$       | Input data (WD) hold time                                                                                            | 0.30 | ns    |
| $t_{CKQ1}$     | Clock High to new data valid on RD (output retained)                                                                 | 3.51 | ns    |
| $t_{CKQ2}$     | Clock High to new data valid on RD (pipelined)                                                                       | 1.43 | ns    |
| $t_{C2CRWH}^1$ | Address collision clk-to-clk delay for reliable read access after write on same address – applicable to opening edge | 0.21 | ns    |
| $t_{C2CWRH}^1$ | Address collision clk-to-clk delay for reliable write access after read on same address – applicable to opening edge | 0.25 | ns    |
| $t_{RSTBQ}$    | RESET Low to data out Low on RD (flow-through)                                                                       | 1.72 | ns    |
|                | RESET Low to data out Low on RD (pipelined)                                                                          | 1.72 | ns    |
| $t_{REMRSTB}$  | RESET removal                                                                                                        | 0.51 | ns    |
| $t_{RECRSTB}$  | RESET recovery                                                                                                       | 2.68 | ns    |
| $t_{MPWRSTB}$  | RESET minimum pulse width                                                                                            | 0.68 | ns    |
| $t_{CYC}$      | Clock cycle time                                                                                                     | 6.24 | ns    |
| $F_{MAX}$      | Maximum frequency                                                                                                    | 160  | MHz   |

**Notes:**

1. For more information, refer to the application note [Simultaneous Read-Write Operations in Dual-Port SRAM for Flash-Based cSoCs and FPGAs](#).
2. For specific junction temperature and voltage supply levels, refer to [Table 2-6 on page 2-6](#) for derating values.

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## 3 – Pin Descriptions and Packaging

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### Supply Pins

**GND****Ground**

Ground supply voltage to the core, I/O outputs, and I/O logic.

**GNDQ****Ground (quiet)**

Quiet ground supply voltage to input buffers of I/O banks. Within the package, the GNDQ plane is decoupled from the simultaneous switching noise originated from the output buffer ground domain. This minimizes the noise transfer within the package and improves input signal integrity. GNDQ must always be connected to GND on the board.

**VCC****Core Supply Voltage**

Supply voltage to the FPGA core, nominally 1.5 V for IGLOO PLUS V5 devices, and 1.2 V or 1.5 V for IGLOO PLUS V2 devices. VCC is required for powering the JTAG state machine in addition to VJTAG. Even when a device is in bypass mode in a JTAG chain of interconnected devices, both VCC and VJTAG must remain powered to allow JTAG signals to pass through the device.

For IGLOO PLUS V2 devices, VCC can be switched dynamically from 1.2 V to 1.5 V or vice versa. This allows in-system programming (ISP) when VCC is at 1.5 V and the benefit of low power operation when VCC is at 1.2 V.

**VCCIBx****I/O Supply Voltage**

Supply voltage to the bank's I/O output buffers and I/O logic. Bx is the I/O bank number. There are four I/O banks on low power flash devices plus a dedicated VJTAG bank. Each bank can have a separate VCCI connection. All I/Os in a bank will run off the same VCCIBx supply. VCCI can be 1.2 V, 1.5 V, 1.8 V, 2.5 V, or 3.3 V, nominal voltage. Unused I/O banks should have their corresponding VCCI pins tied to GND.

**VMVx****I/O Supply Voltage (quiet)**

Quiet supply voltage to the input buffers of each I/O bank. x is the bank number. Within the package, the VMV plane biases the input stage of the I/Os in the I/O banks. This minimizes the noise transfer within the package and improves input signal integrity. Each bank must have at least one VMV connection, and no VMV should be left unconnected. All I/Os in a bank run off the same VMVx supply. VMV is used to provide a quiet supply voltage to the input buffers of each I/O bank. VMVx can be 1.2 V, 1.5 V, 1.8 V, 2.5 V, or 3.3 V, nominal voltage. Unused I/O banks should have their corresponding VMV pins tied to GND. VMV and VCCI should be at the same voltage within a given I/O bank. Used VMV pins must be connected to the corresponding VCCI pins of the same bank (i.e., VMV0 to VCCIB0, VMV1 to VCCIB1, etc.).

**VCCPLA/B/C/D/E/F****PLL Supply Voltage**

Supply voltage to analog PLL, nominally 1.5 V or 1.2 V, depending on the device.

- 1.5 V for IGLOO PLUS V5 devices
- 1.2 V or 1.5 V for IGLOO PLUS V2 devices

When the PLLs are not used, the Microsemi Designer place-and-route tool automatically disables the unused PLLs to lower power consumption. The user should tie unused VCCPLx and VCOMPLx pins to ground. Microsemi recommends tying VCCPLx to VCC and using proper filtering circuits to decouple VCC noise from the PLLs. Refer to the PLL Power Supply Decoupling section of the "Clock Conditioning Circuits in Low Power Flash Devices and Mixed signal FPGAs" chapter of the *IGLOO PLUS FPGA Fabric User's Guide* for a complete board solution for the PLL analog power supply and ground.

There is one VCCPLF pin on IGLOO PLUS devices.

## JTAG Pins

Low power flash devices have a separate bank for the dedicated JTAG pins. The JTAG pins can be run at any voltage from 1.5 V to 3.3 V (nominal). VCC must also be powered for the JTAG state machine to operate, even if the device is in bypass mode; VJTAG alone is insufficient. Both VJTAG and VCC to the part must be supplied to allow JTAG signals to transition the device. Isolating the JTAG power supply in a separate I/O bank gives greater flexibility in supply selection and simplifies power supply and PCB design. If the JTAG interface is neither used nor planned for use, the VJTAG pin together with the TRST pin could be tied to GND.

### TCK Test Clock

Test clock input for JTAG boundary scan, ISP, and UJTAG. The TCK pin does not have an internal pull-up/down resistor. If JTAG is not used, Microsemi recommends tying off TCK to GND through a resistor placed close to the FPGA pin. This prevents JTAG operation in case TMS enters an undesired state.

Note that to operate at all VJTAG voltages, 500  $\Omega$  to 1 k $\Omega$  will satisfy the requirements. Refer to [Table 3-2](#) for more information.

**Table 3-2 • Recommended Tie-Off Values for the TCK and TRST Pins**

| VJTAG          | Tie-Off Resistance           |
|----------------|------------------------------|
| VJTAG at 3.3 V | 200 $\Omega$ to 1 k $\Omega$ |
| VJTAG at 2.5 V | 200 $\Omega$ to 1 k $\Omega$ |
| VJTAG at 1.8 V | 500 $\Omega$ to 1 k $\Omega$ |
| VJTAG at 1.5 V | 500 $\Omega$ to 1 k $\Omega$ |

#### Notes:

1. Equivalent parallel resistance if more than one device is on the JTAG chain
2. The TCK pin can be pulled up/down.
3. The TRST pin is pulled down.

### TDI Test Data Input

Serial input for JTAG boundary scan, ISP, and UJTAG usage. There is an internal weak pull-up resistor on the TDI pin.

### TDO Test Data Output

Serial output for JTAG boundary scan, ISP, and UJTAG usage.

### TMS Test Mode Select

The TMS pin controls the use of the IEEE 1532 boundary scan pins (TCK, TDI, TDO, TRST). There is an internal weak pull-up resistor on the TMS pin.

### TRST Boundary Scan Reset Pin

The TRST pin functions as an active-low input to asynchronously initialize (or reset) the boundary scan circuitry. There is an internal weak pull-up resistor on the TRST pin. If JTAG is not used, an external pull-down resistor could be included to ensure the test access port (TAP) is held in reset mode. The resistor values must be chosen from [Table 3-2](#) and must satisfy the parallel resistance value requirement. The values in [Table 3-2](#) correspond to the resistor recommended when a single device is used, and the equivalent parallel resistor when multiple devices are connected via a JTAG chain.

In critical applications, an upset in the JTAG circuit could allow entrance to an undesired JTAG state. In such cases, Microsemi recommends tying off TRST to GND through a resistor placed close to the FPGA pin.

Note that to operate at all VJTAG voltages, 500  $\Omega$  to 1 k $\Omega$  will satisfy the requirements.

| VQ176      |                  |
|------------|------------------|
| Pin Number | AGLP060 Function |
| 1          | GAA2/IO156RSB3   |
| 2          | IO155RSB3        |
| 3          | GAB2/IO154RSB3   |
| 4          | IO153RSB3        |
| 5          | GAC2/IO152RSB3   |
| 6          | GND              |
| 7          | VCCIB3           |
| 8          | IO149RSB3        |
| 9          | IO147RSB3        |
| 10         | IO145RSB3        |
| 11         | IO144RSB3        |
| 12         | IO143RSB3        |
| 13         | VCC              |
| 14         | IO141RSB3        |
| 15         | GFC1/IO140RSB3   |
| 16         | GFB1/IO138RSB3   |
| 17         | GFB0/IO137RSB3   |
| 18         | VCOMPLF          |
| 19         | GFA1/IO136RSB3   |
| 20         | VCCPLF           |
| 21         | GFA0/IO135RSB3   |
| 22         | GND              |
| 23         | VCCIB3           |
| 24         | GFA2/IO134RSB3   |
| 25         | GFB2/IO133RSB3   |
| 26         | GFC2/IO132RSB3   |
| 27         | IO131RSB3        |
| 28         | IO130RSB3        |
| 29         | IO129RSB3        |
| 30         | IO127RSB3        |
| 31         | IO126RSB3        |
| 32         | IO125RSB3        |
| 33         | IO123RSB3        |
| 34         | IO122RSB3        |
| 35         | IO121RSB3        |

| VQ176      |                   |
|------------|-------------------|
| Pin Number | AGLP060 Function  |
| 36         | IO119RSB3         |
| 37         | GND               |
| 38         | VCCIB3            |
| 39         | GEC1/IO116RSB3    |
| 40         | GEB1/IO114RSB3    |
| 41         | GEC0/IO115RSB3    |
| 42         | GEB0/IO113RSB3    |
| 43         | GEA1/IO112RSB3    |
| 44         | GEA0/IO111RSB3    |
| 45         | GEA2/IO110RSB2    |
| 46         | NC                |
| 47         | FF/GEB2/IO109RSB2 |
| 48         | GEC2/IO108RSB2    |
| 49         | IO106RSB2         |
| 50         | IO107RSB2         |
| 51         | IO104RSB2         |
| 52         | IO105RSB2         |
| 53         | IO102RSB2         |
| 54         | IO103RSB2         |
| 55         | GND               |
| 56         | VCCIB2            |
| 57         | IO101RSB2         |
| 58         | IO100RSB2         |
| 59         | IO99RSB2          |
| 60         | IO98RSB2          |
| 61         | IO97RSB2          |
| 62         | IO96RSB2          |
| 63         | IO95RSB2          |
| 64         | IO94RSB2          |
| 65         | IO93RSB2          |
| 66         | VCC               |
| 67         | IO92RSB2          |
| 68         | IO91RSB2          |
| 69         | IO90RSB2          |

| VQ176      |                  |
|------------|------------------|
| Pin Number | AGLP060 Function |
| 70         | IO89RSB2         |
| 71         | IO88RSB2         |
| 72         | IO87RSB2         |
| 73         | IO86RSB2         |
| 74         | IO85RSB2         |
| 75         | IO84RSB2         |
| 76         | GND              |
| 77         | VCCIB2           |
| 78         | IO83RSB2         |
| 79         | IO82RSB2         |
| 80         | GDC2/IO80RSB2    |
| 81         | IO81RSB2         |
| 82         | GDA2/IO78RSB2    |
| 83         | GDB2/IO79RSB2    |
| 84         | NC               |
| 85         | NC               |
| 86         | TCK              |
| 87         | TDI              |
| 88         | TMS              |
| 89         | VPUMP            |
| 90         | TDO              |
| 91         | TRST             |
| 92         | VJTAG            |
| 93         | GDA1/IO76RSB1    |
| 94         | GDC0/IO73RSB1    |
| 95         | GDB1/IO74RSB1    |
| 96         | GDC1/IO72RSB1    |
| 97         | VCCIB1           |
| 98         | GND              |
| 99         | IO70RSB1         |
| 100        | IO69RSB1         |
| 101        | IO67RSB1         |
| 102        | IO66RSB1         |
| 103        | IO65RSB1         |
| 104        | IO63RSB1         |

| CS201      |                  | CS201      |                  | CS201      |                   |
|------------|------------------|------------|------------------|------------|-------------------|
| Pin Number | AGLP060 Function | Pin Number | AGLP060 Function | Pin Number | AGLP060 Function  |
| H14        | IO64RSB1         | L15        | GDC0/IO73RSB1    | P5         | IO106RSB2         |
| H15        | IO62RSB1         | M1         | IO122RSB3        | P6         | IO105RSB2         |
| J1         | GFA2/IO134RSB3   | M2         | IO124RSB3        | P7         | IO103RSB2         |
| J2         | GFA0/IO135RSB3   | M3         | IO119RSB3        | P8         | IO99RSB2          |
| J3         | GFB2/IO133RSB3   | M4         | GND              | P9         | IO93RSB2          |
| J4         | IO131RSB3        | M5         | IO125RSB3        | P10        | IO92RSB2          |
| J6         | VCCIB3           | M6         | IO98RSB2         | P11        | IO95RSB2          |
| J7         | GND              | M7         | IO96RSB2         | P12        | IO86RSB2          |
| J8         | VCC              | M8         | IO91RSB2         | P13        | IO83RSB2          |
| J9         | GND              | M9         | IO89RSB2         | P14        | VPUMP             |
| J10        | VCCIB1           | M10        | IO82RSB2         | P15        | TRST              |
| J12        | IO61RSB1         | M11        | GDA2/IO78RSB2    | R1         | IO118RSB3         |
| J13        | IO63RSB1         | M12        | GND              | R2         | GEB0/IO113RSB3    |
| J14        | IO68RSB1         | M13        | GDA1/IO76RSB1    | R3         | GEA2/IO110RSB2    |
| J15        | IO66RSB1         | M14        | GDA0/IO77RSB1    | R4         | FF/GEB2/IO109RSB2 |
| K1         | IO130RSB3        | M15        | GDB0/IO75RSB1    | R5         | GEC2/IO108RSB2    |
| K2         | GFC2/IO132RSB3   | N1         | IO117RSB3        | R6         | IO102RSB2         |
| K3         | IO127RSB3        | N2         | IO120RSB3        | R7         | IO101RSB2         |
| K4         | IO129RSB3        | N3         | GND              | R8         | IO104RSB2         |
| K6         | GND              | N4         | GEB1/IO114RSB3   | R9         | IO97RSB2          |
| K7         | VCCIB2           | N5         | IO107RSB2        | R10        | IO88RSB2          |
| K8         | VCCIB2           | N6         | IO100RSB2        | R11        | IO81RSB2          |
| K9         | VCCIB2           | N7         | IO94RSB2         | R12        | GDB2/IO79RSB2     |
| K10        | VCCIB1           | N8         | IO87RSB2         | R13        | TMS               |
| K12        | IO65RSB1         | N9         | IO85RSB2         | R14        | TDI               |
| K13        | IO67RSB1         | N10        | GDC2/IO80RSB2    | R15        | TCK               |
| K14        | IO69RSB1         | N11        | IO90RSB2         |            |                   |
| K15        | IO70RSB1         | N12        | IO84RSB2         |            |                   |
| L1         | IO126RSB3        | N13        | GND              |            |                   |
| L2         | IO128RSB3        | N14        | TDO              |            |                   |
| L3         | IO121RSB3        | N15        | VJTAG            |            |                   |
| L4         | IO123RSB3        | P1         | GEC0/IO115RSB3   |            |                   |
| L12        | GDB1/IO74RSB1    | P2         | GEC1/IO116RSB3   |            |                   |
| L13        | GDC1/IO72RSB1    | P3         | GEA0/IO111RSB3   |            |                   |
| L14        | IO71RSB1         | P4         | GEA1/IO112RSB3   |            |                   |

| CS281      |                  |
|------------|------------------|
| Pin Number | AGLP125 Function |
| H8         | VCC              |
| H9         | VCCIB0           |
| H10        | VCC              |
| H11        | VCCIB0           |
| H12        | VCC              |
| H13        | VCCIB1           |
| H15        | IO77RSB1         |
| H16        | GCB0/IO82RSB1    |
| H18        | GCA1/IO83RSB1    |
| H19        | GCA2/IO85RSB1    |
| J1         | VCOMPLF          |
| J2         | GFA0/IO189RSB3   |
| J4         | VCCPLF           |
| J5         | GFC0/IO193RSB3   |
| J7         | GFA2/IO188RSB3   |
| J8         | VCCIB3           |
| J9         | GND              |
| J10        | GND              |
| J11        | GND              |
| J12        | VCCIB1           |
| J13        | GCC1/IO79RSB1    |
| J15        | GCA0/IO84RSB1    |
| J16        | GCB2/IO86RSB1    |
| J18        | IO76RSB1         |
| J19        | IO78RSB1         |
| K1         | VCCIB3           |
| K2         | GFA1/IO190RSB3   |
| K4         | GND              |
| K5         | IO19RSB0         |
| K7         | IO197RSB3        |
| K8         | VCC              |
| K9         | GND              |
| K10        | GND              |
| K11        | GND              |
| K12        | VCC              |
| K13        | GCC2/IO87RSB1    |

| CS281      |                  |
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| Pin Number | AGLP125 Function |
| K15        | IO89RSB1         |
| K16        | GND              |
| K18        | IO88RSB1         |
| K19        | VCCIB1           |
| L1         | GFB2/IO187RSB3   |
| L2         | IO185RSB3        |
| L4         | GFC2/IO186RSB3   |
| L5         | IO184RSB3        |
| L7         | IO199RSB3        |
| L8         | VCCIB3           |
| L9         | GND              |
| L10        | GND              |
| L11        | GND              |
| L12        | VCCIB1           |
| L13        | IO95RSB1         |
| L15        | IO91RSB1         |
| L16        | NC               |
| L18        | IO90RSB1         |
| L19        | NC               |
| M1         | IO180RSB3        |
| M2         | IO179RSB3        |
| M4         | IO181RSB3        |
| M5         | IO183RSB3        |
| M7         | VCCIB3           |
| M8         | VCC              |
| M9         | VCCIB2           |
| M10        | VCC              |
| M11        | VCCIB2           |
| M12        | VCC              |
| M13        | VCCIB1           |
| M15        | IO122RSB2        |
| M16        | IO93RSB1         |
| M18        | IO92RSB1         |
| M19        | NC               |
| N1         | IO178RSB3        |
| N2         | IO175RSB3        |

| CS281      |                  |
|------------|------------------|
| Pin Number | AGLP125 Function |
| N4         | IO182RSB3        |
| N5         | IO161RSB2        |
| N7         | GEA2/IO164RSB2   |
| N8         | VCCIB2           |
| N9         | IO137RSB2        |
| N10        | IO135RSB2        |
| N11        | IO131RSB2        |
| N12        | VCCIB2           |
| N13        | VPUMP            |
| N15        | IO117RSB2        |
| N16        | IO96RSB1         |
| N18        | IO98RSB1         |
| N19        | IO94RSB1         |
| P1         | IO174RSB3        |
| P2         | GND              |
| P3         | IO176RSB3        |
| P4         | IO177RSB3        |
| P5         | GEA0/IO165RSB3   |
| P15        | IO111RSB2        |
| P16        | IO108RSB2        |
| P17        | GDC1/IO99RSB1    |
| P18        | GND              |
| P19        | IO97RSB1         |
| R1         | IO173RSB3        |
| R2         | IO172RSB3        |
| R4         | GEC1/IO170RSB3   |
| R5         | GEB1/IO168RSB3   |
| R6         | IO154RSB2        |
| R7         | IO149RSB2        |
| R8         | IO146RSB2        |
| R9         | IO138RSB2        |
| R10        | IO134RSB2        |
| R11        | IO132RSB2        |
| R12        | IO130RSB2        |
| R13        | IO118RSB2        |
| R14        | IO112RSB2        |